



Material Content Data Sheet



Sales Product Name		BCW 60B E6327		Issued		29. August 2013		
MA#		MA000553994						
Package		PG-SOT23-3-16		Weight*		8.82 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	noble metal	gold	7440-57-5	0.003	0.03		332	
	non noble metal	arsenic	7440-38-2	0.000	0.00		3	
	inorganic material	silicon	7440-21-3	0.025	0.28	0.31	2840	3175
leadframe	non noble metal	chromium	7440-47-3	0.008	0.09		933	
	inorganic material	silicon	7440-21-3	0.001	0.01		62	
	non noble metal	titanium	7440-32-6	0.003	0.03		311	
	non noble metal	copper	7440-50-8	2.731	30.96	31.09	309564	310870
wire	noble metal	gold	7440-57-5	0.014	0.16	0.16	1623	1623
encapsulation	organic material	carbon black	1333-86-4	0.058	0.66		6561	
	plastics	brominated resin	-	0.087	0.98		9841	
	inorganic material	antimonytrioxide	1309-64-4	0.116	1.31		13121	
	plastics	epoxy resin	-	1.244	14.11		141056	
	inorganic material	silicondioxide	60676-86-0	4.283	48.55	65.61	485496	656075
leadfinish	non noble metal	tin	7440-31-5	0.150	1.70	1.70	16963	16963
plating	noble metal	silver	7440-22-4	0.100	1.13	1.13	11294	11294
*deviation	< 10%		Sum in total:			100,00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com